

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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# HZ1806K102R-10

## UNCONTROLLED DOCUMENT

#### PHYSICAL DIMENSIONS:

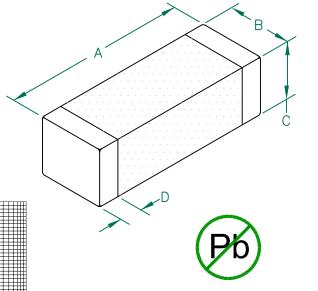
A 4.50 [.177] ± 0.20 [.008]

B 1.60 [.063] ± 0.20 [.008]

C 1.60 [.063] ± 0.20 [.008]

D 0.51 [.020] ± 0.30 [.012]

**IMPEDANCE** 

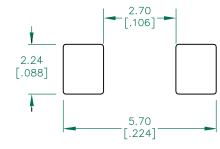


ELECTRICAL CHARACTERISTICS:												
Z @ 100M ( <u>Ω</u> )	1Hz	DCR $\left(\begin{array}{c}\Omega\end{array}\right)$	Rated Current									
Nominal	1000											
Minimum	750											
Maximum	1250	0.15	1,500 mA									

NOTES: UNLESS OTHERWISE SPECIFIED

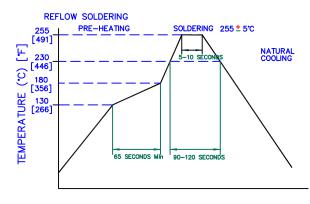
- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 2,000 PCS/REEL, EMBOSSED PLASTIC TAPE.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. OPERATING TEMP. RANGE: -40°C~+125°C (INCLUDING SELF-HEATING)

### LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 [.030] to this dimension.)

#### RECOMMENDED SOLDERING CONDITIONS



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FREQUENCY (MHz)

IZI . R. AND X vs. FREQUENCY

Z vs FREQUENCY IMPEDANCE UNDER DC BIAS

2002/95/EC

	DIMENSIONS ARE IN mm [INCHE	[S].		This print is the property of Lair	d			
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	ADD ODED ATING TEMPERATURE			rights to design or invention are reserved.				
D	ADD OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13		PROJECT/PART NUMBER:	REV	PART	TYPE:	DRAWN BY:
С	UPDATE COMPANY LOGO	03/25/08	JRK	HZ1806K102R-10		D co	-FIRE	JRK
В	CORRECT MIN Z SPEC FROM 700	12/21/06		1 12715706 1	CALE:	NTS	SHEET:	
Α	ORIGINAL DRAFT	12/15/06	JRK				_	
					TOOL #			of 2

AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 6132